

L Number	Hits	Search Text	DB	Time stamp
-	134429	((printed adj circuit) ((circuit wiring) adj board) pwb pcb	USPAT	2004/07/12 10:20
-	492	((printed adj circuit) ((circuit wiring) adj board) pwb pcb) and ((heat adj (shrink shrinkable))	USPAT	2004/07/12 10:20
-	143122	((printed adj circuit) ((circuit wiring) adj board) pwb pcb	USPAT	2004/07/12 10:20
-	437786	((printed adj circuit) ((circuit wiring) adj board) pwb pcb	US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/12 15:07
-	765	((printed adj circuit) ((circuit wiring) adj board) pwb pcb) and ((heat adj (shrink shrinkable))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/12 10:21
-	1211	((361/807-812).CCLS.	USPAT	2004/07/12 15:07
-	3	((361/807-812).CCLS.) and ((heat adj (shrink shrinking shrinkable)) shrink?wrap (shrink adj (wrap wrapped wrapping)))	US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/12 15:08
-	1644	((361/807-812).CCLS.	US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/12 15:08
-	3	((361/807-812).CCLS.) and ((heat adj (shrink shrinking shrinkable)) shrink?wrap (shrink adj (wrap wrapped wrapping)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/12 15:09
-	2325	((361/760,782-783).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/12 15:09
-	8	((361/760,782-783).CCLS.) and ((heat adj (shrink shrinking shrinkable)) shrink?wrap (shrink adj (wrap wrapped wrapping)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/12 15:09
-	763	((439/874).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/23 11:59
-	26	((439/874).CCLS.) and ((heat?shrink heat?shrinkable (heat adj (shrink shrinkable)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/23 12:04

-	4842	(439/65-75).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/07/23 12:04
-	6	((439/65-75).CCLS.) and (heat?shrink heat?shrinkable (heat adj (shrink shrinkable)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/07/23 12:04